



Cohu's Semiconductor Equipment Group Introduces Next Generation Solutions for Mobile Device Testing

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POWAY, Calif.--(BUSINESS WIRE)--Aug. 29, 2012-- Cohu, Inc. (NASDAQ:COHU) today announced new solutions from its Semiconductor Equipment Group for use in testing mobile devices.

The company's proprietary T-Core thermal technology is being integrated with its Delta *EDGE* handler, providing a production test handling solution for the ICs that power a wide range of smart phones, tablets, and other consumer devices. In addition, the T-Core thermal subsystem can be incorporated in burn-in and system level test equipment, for cost-effective, parallel testing of hundreds of ICs.

"We are excited to bring our active thermal control technology, long considered the benchmark for testing mid and high power processors, to new applications in the rapidly-expanding mobile market" said Luis Müller, President of Cohu's Semiconductor Equipment Group.

The implementation of T-Core in the *EDGE* handler provides customers with a flexible solution for testing both standard ICs and thermal dissipative processors. The *EDGE* is capable of testing up to sixteen standard ICs or four microprocessors in parallel, at temperatures from ambient to 125 degrees Celsius. The product will be displayed at Semicon Taiwan September 5-7, booth #476.

About Cohu:

Cohu is a supplier of test handling, burn-in, thermal subsystems and MEMS test solutions used by the global semiconductor industry as well as a supplier of microwave communications and video equipment.

For press releases and other information of interest to investors, please visit Cohu's website at www.cohu.com.



Source: Cohu, Inc.

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